

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Wendy Lee Wilkins
Title : Die-First Multi-Chip Modules and Methods of . . .
Application No. : 10/724,981
Confirmation No. : 1888
Filing Date : 11/30/03
Examiner : Michael A. Brown
Group Art Unit : 3764
Attorney Docket : 783403605015

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

REPLY TO OFFICE ACTION

The following remarks are in response to the Office Action mailed June 12, 2007.

Any fee due for this submission may be charged to the Jones Day Deposit Account No. 501432, reference 783403605015.